

**FX601** 

**P-Channel Silicon MOSFET** 

# **Ultrahigh-Speed Switching Applications**

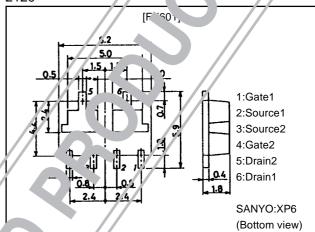
#### **Features**

- · Composite type composed of tow low ON-resistance P-channel MOSFET chips for ultrahigh-speed switching and low-voltage drive.
- · Facilitates high-density mounting.
- Tth FX601 is formed with two chips, each being equivalent to the 2SJ316, placed in one package.
- · Matched pair characteristics.

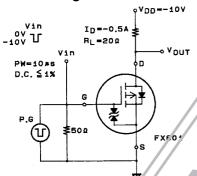
## Package Dimensions

unit:mm

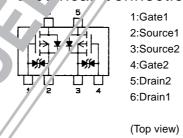
2120



#### Switching Time Test CIrcuit



#### Tec rical Connection



## Specifications

Absolute Maximum Ratings = 25%

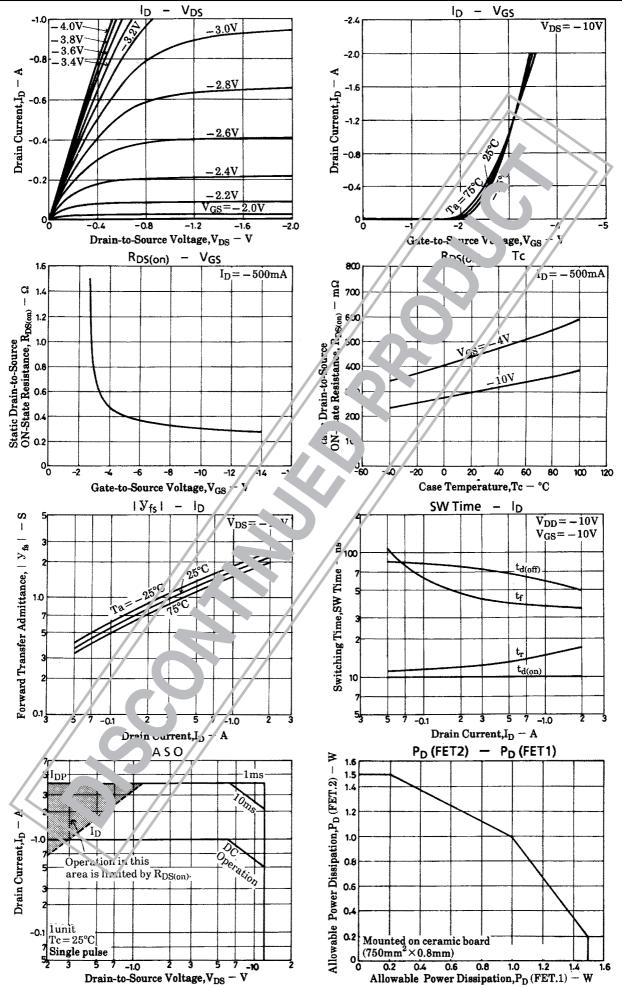
Farameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	Voss		-12	V
Gate-to-Source: Voltage	V <sub>GSS</sub>		±12	V
Drain Currerit (DC)	ID		-1	Α
Drain Cur.er.ι (Pulse)	I <sub>DP</sub>	PW≤10µs, duty cycle≤1%	-4	Α
Allowable Power C Sup on	PD	Tc=25°C, 1unit	6	W
	PD	Mounted on ceramic board (750mm <sup>2</sup> ×0.8mm) 1unit	1.5	W
Total Dissipation	PT	Mounted on ceramic board (750mm <sup>2</sup> ×0.8mm)	2	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

· Marking:601 Continued on next page.

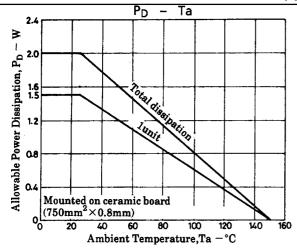
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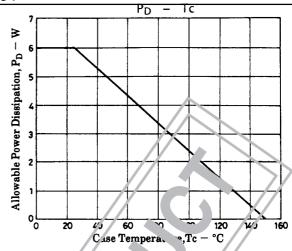
## Electrical Characteristics at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Onit
D-S Breakdown Voltage	V(BR)DSS	I <sub>D</sub> =-1mA, V <sub>GS</sub> =0	-/12			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =-12V, V <sub>GS</sub> =0			-100	μΑ
Gate-to-Source Leakage Current	IGSS	$V_{GS}=\pm 12, V_{DS}=0$	//		±10	μΑ
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =-10V, I <sub>D</sub> =-1mA	-1.0		- 2.0	V
Forward Transfer Admittance	Yfs	V <sub>DS</sub> =-10V, I <sub>D</sub> =-500mA	0	1.2		S
Static Drain-to-Source ON-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =-500mA, V <sub>GS</sub> =-10V		0.3	0.42	Ω
	R <sub>DS(on)</sub>	I <sub>D</sub> =-500mA, V <sub>GS</sub> =-4V		د.۔.0	0.63	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =-10V, f=1MHz		170	77	pF
Output Capacitance	Coss	V <sub>DS</sub> =-10V, f=1MHz		170	77	pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =-10V, f=1MHz		40	7	pF
Turn-ON Delay Time	t <sub>d(on)</sub>	See Specified Test Circuit		10		ns
Rise Time	t <sub>r</sub>	See Specified Test Circuit		(4		ns
Turn-OFF Delay Time	td(off)	See Specified Test Circuit		70		ns
Fall Time	t <sub>f</sub>	See Specified Test Circuit		40		ns
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1A, V <sub>GS</sub> =0		-0.9		V









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